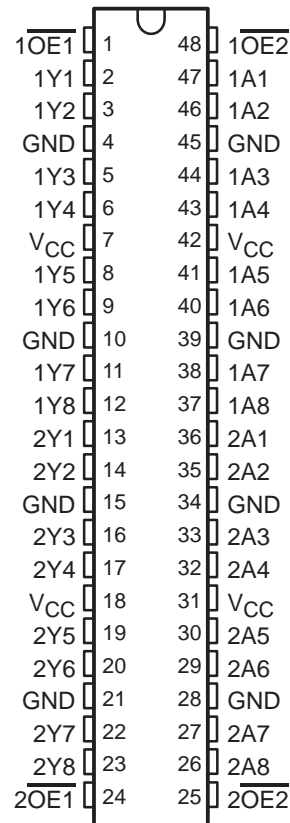


# SN54AHC16540, SN74AHC16540 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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- **Members of the Texas Instruments Widebus™ Family**
- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Operating Range 2-V to 5.5-V  $V_{CC}$**
- **Distributed  $V_{CC}$  and GND Pins Minimize High-Speed Switching Noise**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015**
- **Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

SN54AHC16540 . . . WD PACKAGE  
SN74AHC16540 . . . DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



## description

These 16-bit buffers and bus drivers provide a high-performance bus interface for wide data paths.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all corresponding outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54AHC16540 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74AHC16540 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

FUNCTION TABLE  
(each 8-bit buffer/driver)

| INPUTS           |                  |   | OUTPUT<br>Y |
|------------------|------------------|---|-------------|
| $\overline{OE1}$ | $\overline{OE2}$ | A |             |
| L                | L                | L | H           |
| L                | L                | H | L           |
| H                | X                | X | Z           |
| X                | H                | X | Z           |



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 **TEXAS  
INSTRUMENTS**

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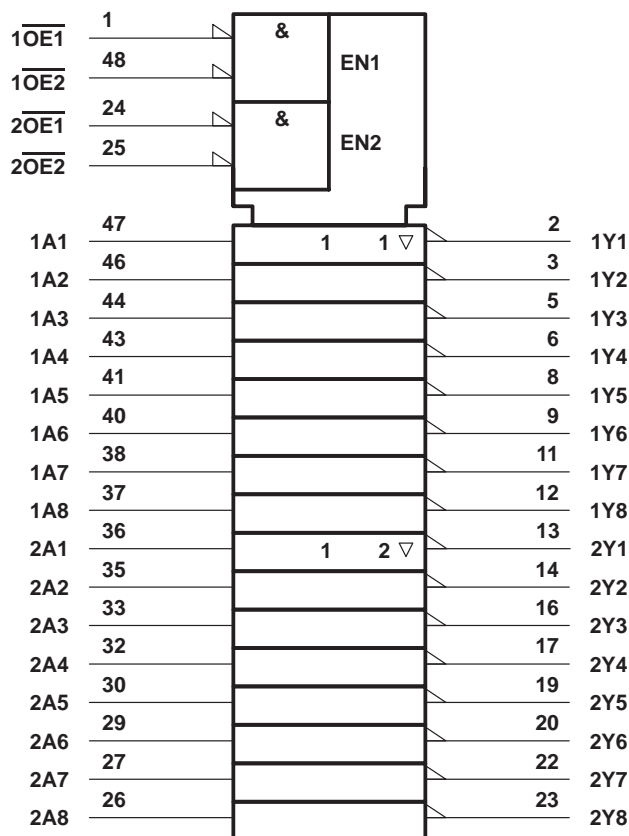
# SN54AHC16540, SN74AHC16540

## 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

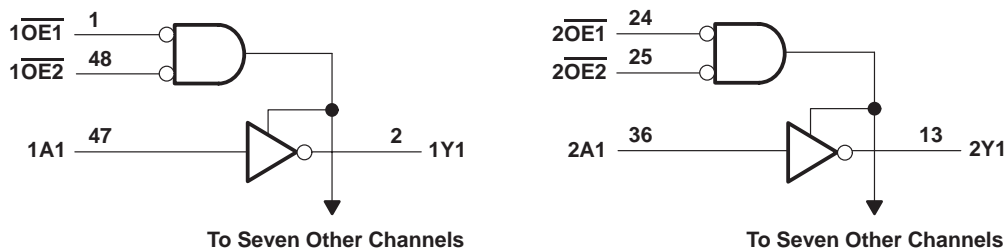
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#### logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)





# SN54AHC16540, SN74AHC16540

## 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS  | V <sub>CC</sub> | T <sub>A</sub> = 25°C |     |       | SN54AHC16540 |      | SN74AHC16540 |      | UNIT |
|-----------------|--|-----------------|-----------------------|-----|-------|--------------|------|--------------|------|------|
|                 |  |                 | MIN                   | TYP | MAX   | MIN          | MAX  | MIN          | MAX  |      |
| V <sub>OH</sub> | I <sub>OH</sub> = -50 μA   | 2 V             | 1.9                   | 2   |       | 1.9          |      | 1.9          | V    |      |
|                 |  | 3 V             | 2.9                   | 3   |       | 2.9          |      | 2.9          |      |      |
|                 |  | 4.5 V           | 4.4                   | 4.5 |       | 4.4          |      | 4.4          |      |      |
|                 | I <sub>OH</sub> = -4 mA  | 3 V             | 2.58                  |     |       | 2.48         |      | 2.48         |      |      |
|                 | I <sub>OH</sub> = -8 mA  | 4.5 V           | 3.94                  |     |       | 3.8          |      | 3.8          |      |      |
| V <sub>OL</sub> | I <sub>OL</sub> = 50 μA  | 2 V             |                       |     | 0.1   |              | 0.1  |              | V    |      |
|                 |  | 3 V             |                       |     | 0.1   |              | 0.1  |              |      |      |
|                 |  | 4.5 V           |                       |     | 0.1   |              | 0.1  |              |      |      |
|                 | I <sub>OL</sub> = 4 mA   | 3 V             |                       |     | 0.36  |              | 0.5  |              |      | 0.44 |
|                 | I <sub>OL</sub> = 8 mA   | 4.5 V           |                       |     | 0.36  |              | 0.5  |              |      | 0.44 |
| I <sub>I</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND  | 0 V to 5.5 V    |                       |     | ±0.1  |              | ±1*  |              | ±1   | μA   |
| I <sub>OZ</sub> | V <sub>O</sub> = V <sub>CC</sub> or GND,<br>V <sub>I</sub> (OE) = V <sub>IL</sub> or V <sub>IH</sub> | 5.5 V           |                       |     | ±0.25 |              | ±2.5 |              | ±2.5 | μA   |
| I <sub>CC</sub> | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0  | 5.5 V           |                       |     | 4     |              | 40   |              | 40   | μA   |
| C <sub>i</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND  | 5 V             |                       | 2   | 10    |              |      |              | 10   | pF   |
| C <sub>o</sub>  | V <sub>O</sub> = V <sub>CC</sub> or GND  | 5 V             |                       | 3   |       |              |      |              |      | pF   |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested at V<sub>CC</sub> = 0 V.

switching characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER          | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE       | T <sub>A</sub> = 25°C |       |        | SN54AHC16540 |        | SN74AHC16540 |      | UNIT |
|--------------------|--------------|-------------|------------------------|-----------------------|-------|--------|--------------|--------|--------------|------|------|
|                    |              |             |                        | MIN                   | TYP   | MAX    | MIN          | MAX    | MIN          | MAX  |      |
| t <sub>PLH</sub>   | A            | Y           | C <sub>L</sub> = 15 pF |                       | 4.8** | 8.4**  | 1**          | 10**   | 1            | 10   | ns   |
| t <sub>PHL</sub>   |              |             |                        |                       |       |        |              |        |              |      |      |
| t <sub>PZH</sub>   | OE           | Y           | C <sub>L</sub> = 15 pF |                       | 6.8** | 10.6** | 1**          | 12.5** | 1            | 12.5 | ns   |
| t <sub>PZL</sub>   |              |             |                        |                       |       |        |              |        |              |      |      |
| t <sub>PHZ</sub>   | OE           | Y           | C <sub>L</sub> = 15 pF |                       | 6.8** | 11.5** | 1**          | 12.5** | 1            | 12.5 | ns   |
| t <sub>PLZ</sub>   |              |             |                        |                       |       |        |              |        |              |      |      |
| t <sub>PLH</sub>   | A            | Y           | C <sub>L</sub> = 50 pF |                       | 7.7   | 11     | 1            | 12.5   | 1            | 12.5 | ns   |
| t <sub>PHL</sub>   |              |             |                        |                       |       |        |              |        |              |      |      |
| t <sub>PZH</sub>   | OE           | Y           | C <sub>L</sub> = 50 pF |                       | 9.7   | 14.1   | 1            | 16     | 1            | 16   | ns   |
| t <sub>PZL</sub>   |              |             |                        |                       |       |        |              |        |              |      |      |
| t <sub>PHZ</sub>   | OE           | Y           | C <sub>L</sub> = 50 pF |                       | 9.4   | 14     | 1            | 16     | 1            | 16   | ns   |
| t <sub>PLZ</sub>   |              |             |                        |                       |       |        |              |        |              |      |      |
| t <sub>sk(o)</sub> |              |             | C <sub>L</sub> = 50 pF |                       |       | 1.5*** |              |        |              | 1.5  | ns   |

\*\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

\*\*\* On products compliant to MIL-PRF-38535, this parameter does not apply.

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SN54AHC16540, SN74AHC16540  
16-BIT BUFFERS/DRIVERS  
WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

| PARAMETER   | FROM (INPUT)    | TO (OUTPUT) | LOAD CAPACITANCE     | $T_A = 25^\circ\text{C}$ |      |     | SN54AHC16540 |     | SN74AHC16540 |     | UNIT |
|-------------|-----------------|-------------|----------------------|--------------------------|------|-----|--------------|-----|--------------|-----|------|
|             |                 |             |                      | MIN                      | TYP  | MAX | MIN          | MAX | MIN          | MAX |      |
| $t_{PLH}$   | A               | Y           | $C_L = 15\text{ pF}$ | 3.7*                     | 6*   | 1*  | 7*           | 1   | 7            | ns  |      |
| $t_{PHL}$   |                 |             |                      | 3.7*                     | 6*   | 1*  | 7*           | 1   | 7            |     |      |
| $t_{PZH}$   | $\overline{OE}$ | Y           | $C_L = 15\text{ pF}$ | 4.7*                     | 7.3* | 1*  | 8.5*         | 1   | 8.5          | ns  |      |
| $t_{PZL}$   |                 |             |                      | 4.7*                     | 7.3* | 1*  | 8.5*         | 1   | 8.5          |     |      |
| $t_{PHZ}$   | $\overline{OE}$ | Y           | $C_L = 15\text{ pF}$ | 4.5*                     | 7.2* | 1*  | 8.5*         | 1   | 8.5          | ns  |      |
| $t_{PLZ}$   |                 |             |                      | 4.5*                     | 7.2* | 1*  | 8.5*         | 1   | 8.5          |     |      |
| $t_{PLH}$   | A               | Y           | $C_L = 50\text{ pF}$ | 5.2                      | 8    | 1   | 9            | 1   | 8.5          | ns  |      |
| $t_{PHL}$   |                 |             |                      | 5.2                      | 8    | 1   | 9            | 1   | 8.5          |     |      |
| $t_{PZH}$   | $\overline{OE}$ | Y           | $C_L = 50\text{ pF}$ | 6.2                      | 9.3  | 1   | 10.5         | 1   | 10.5         | ns  |      |
| $t_{PZL}$   |                 |             |                      | 6.2                      | 9.3  | 1   | 10.5         | 1   | 10.5         |     |      |
| $t_{PHZ}$   | $\overline{OE}$ | Y           | $C_L = 50\text{ pF}$ | 6                        | 9.2  | 1   | 10.5         | 1   | 10.5         | ns  |      |
| $t_{PLZ}$   |                 |             |                      | 6                        | 9.2  | 1   | 10.5         | 1   | 10.5         |     |      |
| $t_{sk(o)}$ |                 |             | $C_L = 50\text{ pF}$ |                          | 1**  |     |              |     | 1            | ns  |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

\*\* On products compliant to MIL-PRF-38535, this parameter does not apply.

noise characteristics,  $V_{CC} = 5\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (see Note 4)

| PARAMETER   |  | SN74AHC16540 |      |     | UNIT |
|-------------|--|--------------|------|-----|------|
|             |  | MIN          | TYP  | MAX |      |
| $V_{OL(P)}$ | Quiet output, maximum dynamic $V_{OL}$ |              | 0.6  |     | V    |
| $V_{OL(V)}$ | Quiet output, minimum dynamic $V_{OL}$ |              | -0.3 |     | V    |
| $V_{OH(V)}$ | Quiet output, minimum dynamic $V_{OH}$ |              | 4.7  |     | V    |
| $V_{IH(D)}$ | High-level dynamic input voltage       | 3.5          |      |     | V    |
| $V_{IL(D)}$ | Low-level dynamic input voltage        |              |      | 1.5 | V    |

NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER |                               | TEST CONDITIONS             | TYP | UNIT |
|-----------|-------------------------------|-----------------------------|-----|------|
| $C_{pd}$  | Power dissipation capacitance | No load, $f = 1\text{ MHz}$ | 13  | pF   |

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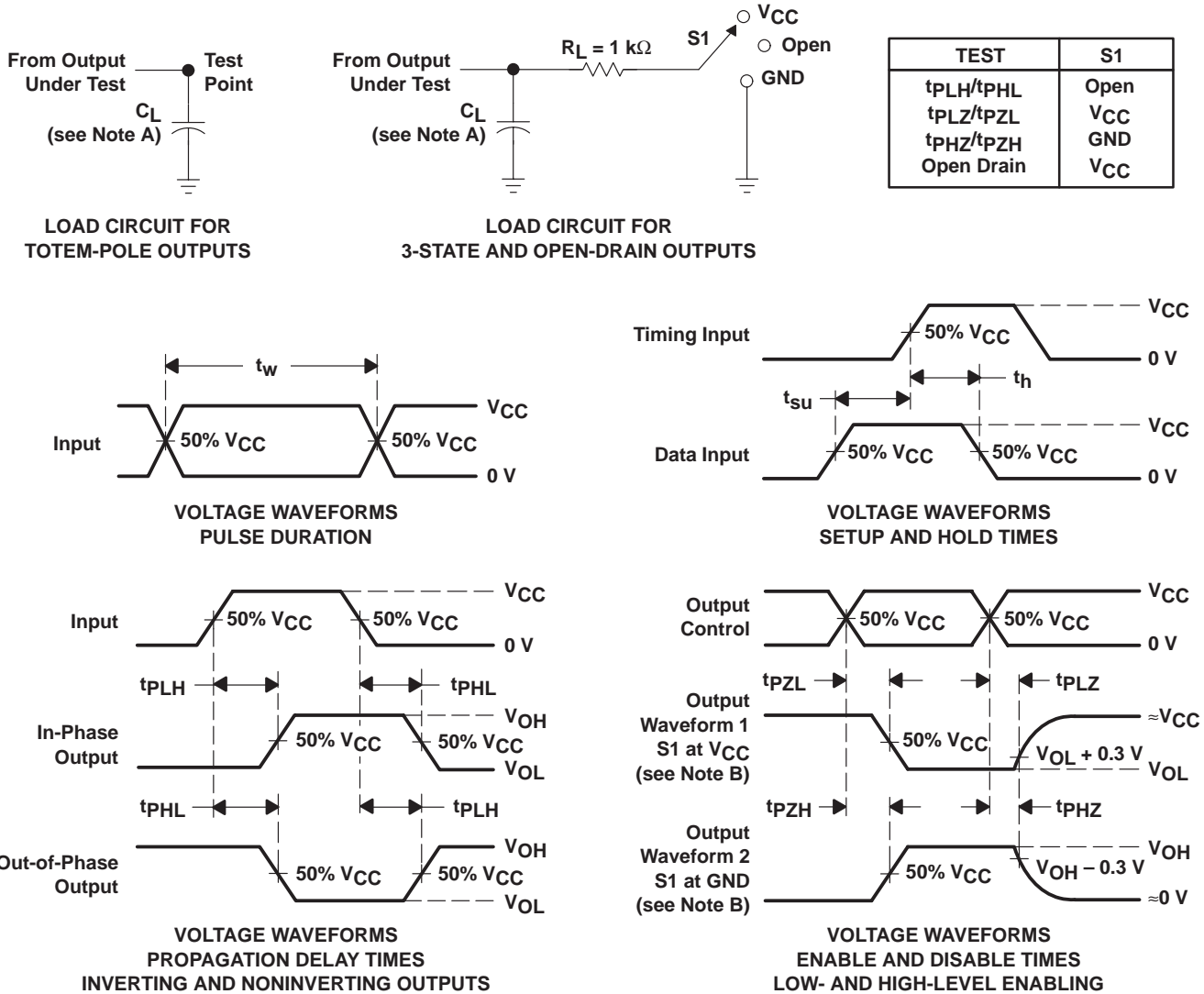


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**16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**PARAMETER MEASUREMENT INFORMATION**



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1$  MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 3$  ns,  $t_f \leq 3$  ns.  
 D. The outputs are measured one at a time with one input transition per measurement.

**Figure 1. Load Circuit and Voltage Waveforms**

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74AHC16540DGGRE4 | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74AHC16540DGGRG4 | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74AHC16540DGVRE4 | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74AHC16540DGVRG4 | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC16540DGGR | ACTIVE                | TSSOP        | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC16540DGVR | ACTIVE                | TVSOP        | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC16540DL   | ACTIVE                | SSOP         | DL              | 48   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC16540DLG4 | ACTIVE                | SSOP         | DL              | 48   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AHC16540DGGR | TSSOP        | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 15.8    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74AHC16540DGVR | TVSOP        | DGV             | 48   | 2000 | 330.0              | 16.4               | 7.1     | 10.2    | 1.6     | 12.0    | 16.0   | Q1            |



**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHC16540DGGR | TSSOP        | DGG             | 48   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74AHC16540DGVR | TVSOP        | DGV             | 48   | 2000 | 346.0       | 346.0      | 33.0        |

DL (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-118

DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

DGV (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

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| DLP® Products               | <a href="http://www.dlp.com">www.dlp.com</a>                       |
| DSP                         | <a href="http://dsp.ti.com">dsp.ti.com</a>                         |
| Clocks and Timers           | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>           |
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|                    |  |
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